

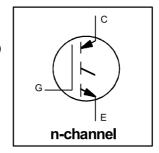
# IRGP450U

### INSULATED GATE BIPOLAR TRANSISTOR

UltraFast IGBT

#### **Features**

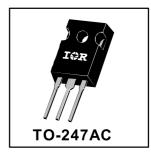
- Switching-loss rating includes all "tail" losses
- Optimized for high operating frequency (over 5kHz) See Fig. 1 for Current vs. Frequency curve



$$V_{CES}$$
 = 500V  
 $V_{CE(sat)} \le 3.2V$   
 $@V_{GE}$  = 15V,  $I_C$  = 33A

#### **Description**

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.



## **Absolute Maximum Ratings**

	Parameter	Max.	Units
V <sub>CES</sub>	Collector-to-Emitter Voltage	500	V
I <sub>C</sub> @ T <sub>C</sub> = 25°C	Continuous Collector Current	59	
I <sub>C</sub> @ T <sub>C</sub> = 100°C	Continuous Collector Current	33	A
I <sub>CM</sub>	Pulsed Collector Current ①	120	
I <sub>LM</sub>	Clamped Inductive Load Current ②	120	
$V_{GE}$	Gate-to-Emitter Voltage	±20	V
E <sub>ARV</sub>	Reverse Voltage Avalanche Energy 3	20	mJ
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Maximum Power Dissipation	200	W
P <sub>D</sub> @ T <sub>C</sub> = 100°C	Maximum Power Dissipation	78	
TJ	Operating Junction and	-55 to +150	
T <sub>STG</sub>	Storage Temperature Range		°C
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

#### **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	_	_	0.64	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface		0.24		°C/W
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	_	_	40	
Wt	Weight	_	6 (0.21)	_	g (oz)